

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	BRS	L1	389	((form\$3 or deposit\$3) same ((conductiv or metal or metallic or Cu W or Al or Ni) and ("contact pad" and bump))	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:38			0
2	BRS	L7	211	etching and 1	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:37			0
3	BRS	L13	1607	IMD or "implanted medical device"	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:39			0
4	BRS	L19	1208	IMD or "implanted medical device"13 and 1	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:38			0
5	BRS	L25	1	13 and 1	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:38			0
6	BRS	L31	1	((conductiv or metal or metallic or Cu W or Al or Ni) and ("contact pad" and bump)) and 19	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:39			0
7	BRS	L37	423	"implanted medical device"	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/12/15 18:40			0